Zero-Delay Clock Buffer

Product Features

- Maximum rated frequency: 133 MHz
- Low cycle-to-cycle jitter
- Input to output delay, less than 300ps
- Internal feedback allows outputs to be synchronized to the clock input
- 5V tolerant input*
- Operates at 3.3V V_{DD}
- Packages (Pb-free and Green available):
  150-mil SOIC (W)
  173-mil TSSOP (L)

* *CLKIN must reference the same voltage thresholds for the PLL to deliver zero delay skewing*

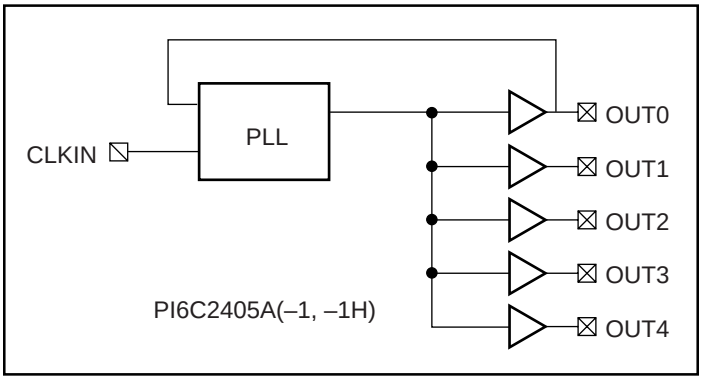
Functional Description

The PI6C2405A is a PLL based, zero-delay buffer, with the ability to distribute five outputs of up to 133MHz at 3.3V. All the outputs are distributed from a single clock input CLKIN and output OUT0 performs zero delay by connecting a feedback to PLL.

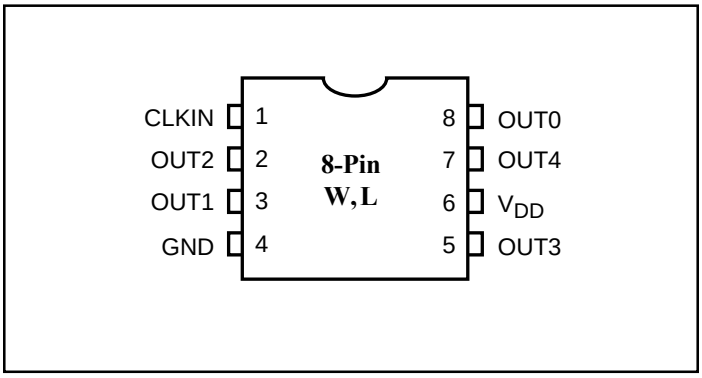
An internal feedback on OUT0 is used to synchronize the outputs to the input; the relationship between loading of this signal and the outputs determines the input-output delay. PI6C2405A is characterized for both commercial and industrial operation.

PI6c2405A-1H is a high-drive version of PI6C2405A-1

Block Diagram: PI6C2405A



Pin Configuration: PI6C2405A

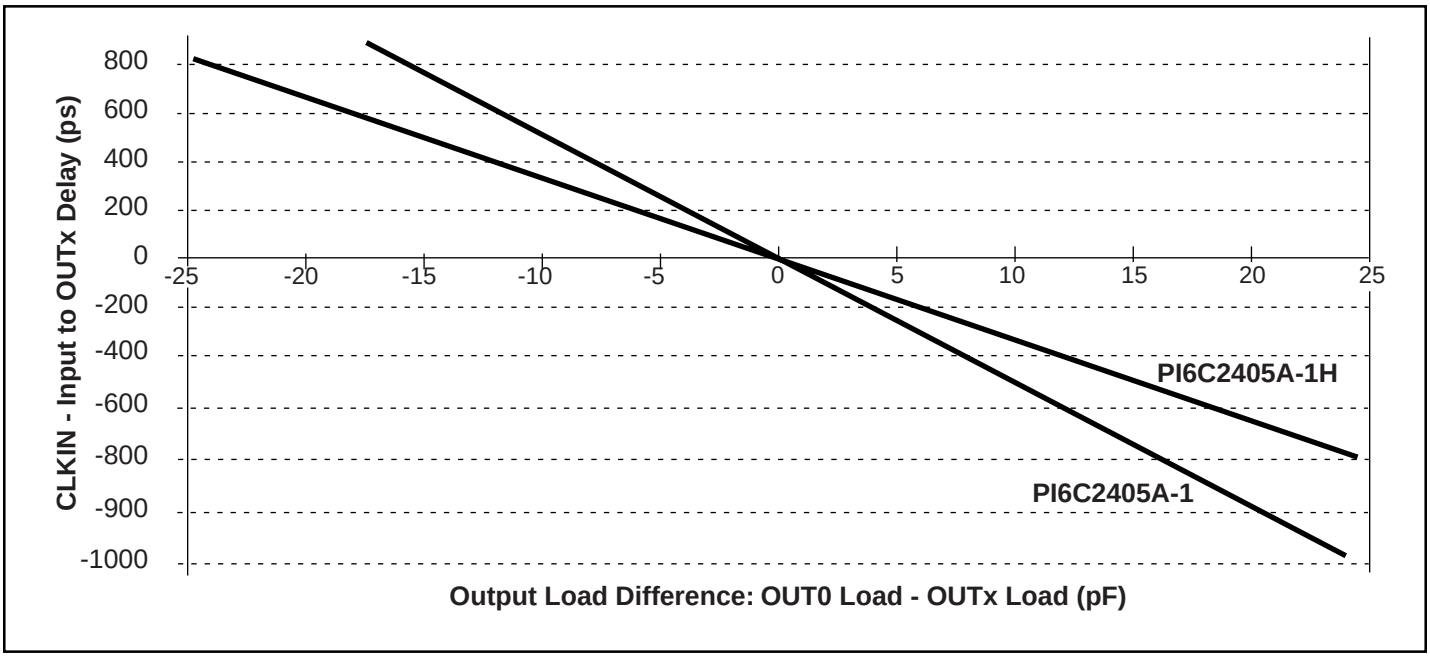


Pin Description for PI6C2405A

Pin	Signal	Description
1	CLKIN	Input clock reference frequency (weak pull-down)
2, 3, 5, 7	OUT[1-4]	Clock outputs
4	GND	Ground
6	V_{DD}	3.3V supply
8	OUT0	Clock output, internal PLL feedback (weak pull-down)

Zero Delay and Skew Control

CLKIN Input to OUTx Delay vs. Difference in Loading between OUT0 pin and OUTx pins



The relationship between loading of the OUT0 signal and other outputs determines the input-output delay. Zero delay is achieved when all outputs, including feedback, are loaded equally.

Maximum Ratings

Supply Voltage to Ground Potential	–0.5V to +7.0V
DC Input Voltage (Except CLKIN)	–0.5V to V_{DD} +0.5V
DC Input Voltage CLKIN	–0.5 to 7V
Storage Temperature	–65ºC to +150ºC
Maximum Soldering Temperature (10 seconds)	260ºC
Junction Temperature	150ºC
Static Discharge Voltage (per MIL-STD-883, Method 3015)	>2000V

Operating Conditions (V_{CC} = 3.3V ±0.3V)

Parameter	Description	Min.	Max.	Units
V_{DD}	Supply Voltage	3.0	3.6	V
T_A	Commerical Operating Temperature	0	70	ºC
	Industrial Operating Temperature	–40	85	
C_L	Load Capacitance, below 100 MHz	—	30	pF
	Load Capacitance, from 100 MHz to 133 MHz	—	15	
C_{IN}	Input Capacitance	—	7	

DC Electrical Characteristics for Industrial Temperature Devices

Parameter	Description	Test Conditions	Min.	Max.	Units
V_{IL}	Input LOW Voltage			0.8	V
V_{IH}	Input HIGH Voltage		2.0		
I_{IL}	Input LOW Current	V_{IN} = 0V		50	µA
I_{IH}	Input HIGH Current	V_{IN} = V_{DD}		125	
V_{OL}	Output LOW Voltage	I_{OL} = 8mA (–1); I_{OL} = 12mA (–1H)		0.4	V
V_{OH}	Output HIGH Voltage	I_{OH} = –8mA (–1); I_{OH} = –12mA (–1H)	2.4		
I_{DD}	Supply Current	Unloaded outputs 100 MHz, Select inputs at V_{DD} or GND		54	mA
		Unloaded outputs 66 MHz, CLKIN		39	

AC Electrical Characteristics for Industrial Temperature Devices

Parameters	Name	Test Conditions	Min.	Typ.	Max.	Units
F_O	Output Frequency	30pF load	10		100	MHz
		15pF load,			133	
t_{DC}	Duty Cycle(1) (–1)	Measured at V_{DD}/2, F_{OUT} <66.67MHz 30pF load	40	50	60	%
		Measured at V_{DD}/2, F_{OUT} <45MHz 15pF load	45		55	
	Duty Cycle(1) (–1H)	Measured at V_{DD}/2, F_{OUT} <100MHz 15pF load	40		60	
		Measured at V_{DD}/2V, F_{OUT} <45MHz 30pF load	45		55	
t_R	Rise Time(1) (–1)	Measured between 0.8V and 2.0V, 30pF load			2.2	ns
		Measured between 0.8V and 2.0V, 15pF load			1.5	
	Rise Time(1) (–1H)	Measured between 0.8V and 2.0V, 30pF load			1.5	
t_F	Fall Time(1) (–1)	Measured between 0.8V and 2.0V, 30pF load			2.2	
		Measured between 0.8V and 2.0V, 15pF load			1.5	
	Fall Time(1) (–1H)	Measured between 0.8V and 2.0V, 30pF load			1.5	
$t_{SK(O)}$	Output to Output Skew (–1,–1H)(1)	All outputs equally loaded			200	ps
t_0	Delay, CLKIN Rising Edge to OUT0 Rising Edge(1)	Measured at V_{DD}/2		0	±300	
$t_{SK(D)}$	Device-to-Device Skew(1)	Measured at V_{DD}/2 on OUT0 pins of devices		0	600	
t_{SLEW}	Output Slew Rate(1)	Measured between 0.8V & 2.0V on –1H device using Test Crt #2	1			V/ns
t_{JIT}	Cycle-to-Cycle Jitter(1) (–1,–1H)	Measured at 66.67 MHz, loaded 30pF load			200	ps
		Measured at 133 MHz, loaded 15pF load			100	
t_{LOCK}	PLL Lock Time(1)	Stable power supply, valid clocks presented on CLKIN pin			1.0	ms

Notes: 1.See Switching Waveforms on page 5.

DC Electrical Characteristics for Commercial Temperature Devices

Parameter	Description	Test Conditions	Min.	Max.	Units
V_{IL}	Input LOW Voltage	—	—	0.8	V
V_{IH}	Input HIGH Voltage	—	2.0	—	
I_{IL}	Input LOW Current	V_{IN} = 0V	—	50	µA
I_{IH}	Input HIGH Current	V_{IN} = V_{DD}	—	125	
V_{OL}	Output LOW Voltage	I_{OL} = 8mA (–1); I_{OL} = 12mA (–1H)	—	0.4	V
V_{OH}	Output HIGH Voltage	I_{OH} = –8mA (–1); I_{OH} = –12mA (–1H)	2.4	—	
I_{DD}	Supply Current	Unloaded outputs 100 MHz Select Inputs @ V_{DD} or GND	—	54	mA
I_{DD}	Supply Current	Unloaded outputs, 66.67 MHz, Select inputs at V_{DD} or GND	—	39	

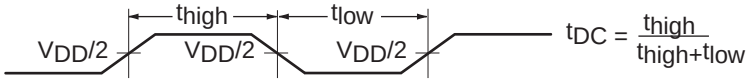
AC Electrical Characteristics for Commercial Temperature Device

Parameters	Name	Test Conditions	Min.	Typ.	Max.	Units
F_O	Output Frequency	30pF load	10		100	MHz
		15pF load,			133	
t_{DC}	Duty Cycle (–1)	Measured at V_{DD}/2, F_O< 66MHz, 30pF	40	50	60	%
	Duty Cycle(1) (–1H)	Measured at V_{DD}/2, F_O< 66MHz, 30pF	45	50	55	
t_R	Rise Time(1) @30pF	Measured between 0.8V and 2.0V			2.2	ns
	Rise Time(1) @15pF				1.5	
	Rise Time(1) @30pF (–1H)				1.5	
t_F	Fall Time(1) @30pF				2.2	
	Fall Time(1) @15pF				1.5	
	Fall Time(1) @30pF (–1H)				1.5	
$t_{SK(O)}$	Output to Output Skew(1) (–1,–1H)	All outputs equally loaded, V_{DD}/2			200	ps
t_0	Input to Output Delay, CLKIN Rising Edge to OUT0 Rising Edge(1)	Measured at V_{DD}/2		0	±300	
$t_{SK(D)}$	Device to Device Skew(1)	Measured at V_{DD}/2 on OUT0 pins of devices		0	600	
t_{SLEW}	Output Slew Rate(1)	Measured between 0.8V and 2.0V on –1H device using Test Circuit #2	1			V/ns
t_{JIT}	Cycle-to-Cycle Jitter (–1,–1H)	Measured at 66.67 MHz, loaded 30pF outputs			200	ps
		Measured at 133 MHz, loaded 15pF outputs			100	
t_{LOCK}	PLL Lock Time	Stable power supply, valid clocks presented on CLKIN pins			1.0	ms

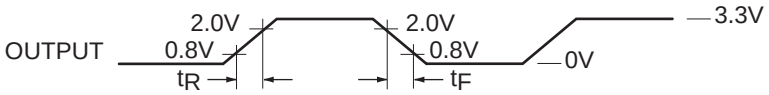
Notes:
1. See Switching Waveforms on page 5

Switching Waveforms

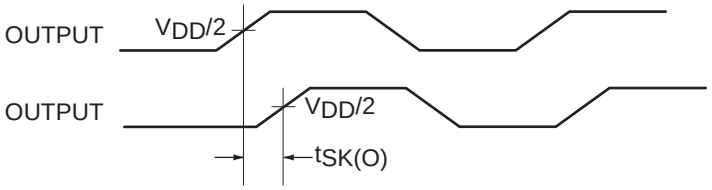
Duty Cycle Timing



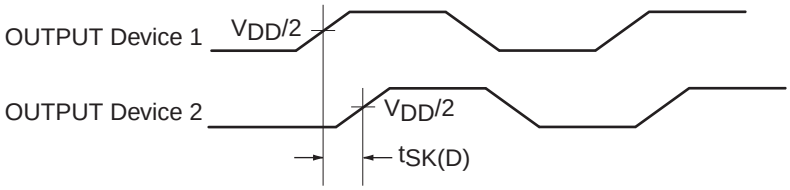
All Outputs Rise/Fall Time



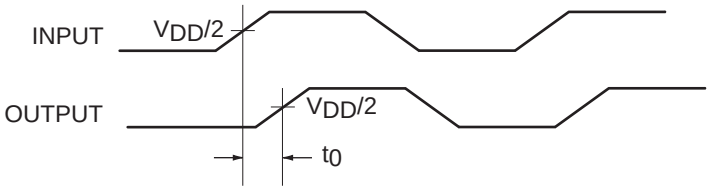
Output-Output Skew



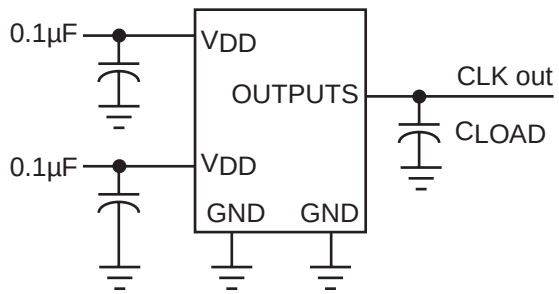
Device-Device Skew



Input-Output Propagation Delay

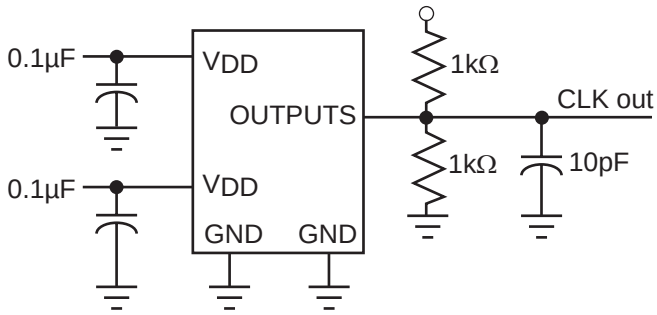


Test Circuit 1



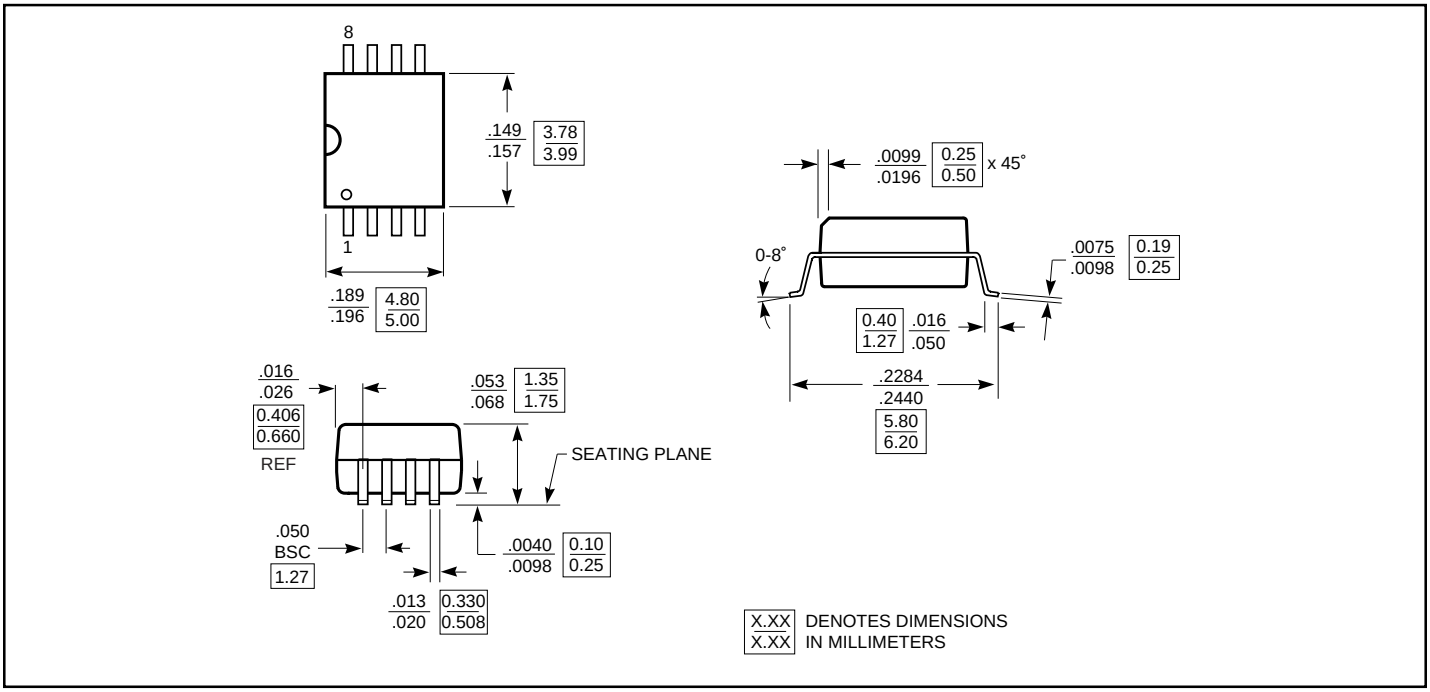
Test Circuit for all parameters except t_{SLEW}

Test Circuit 2

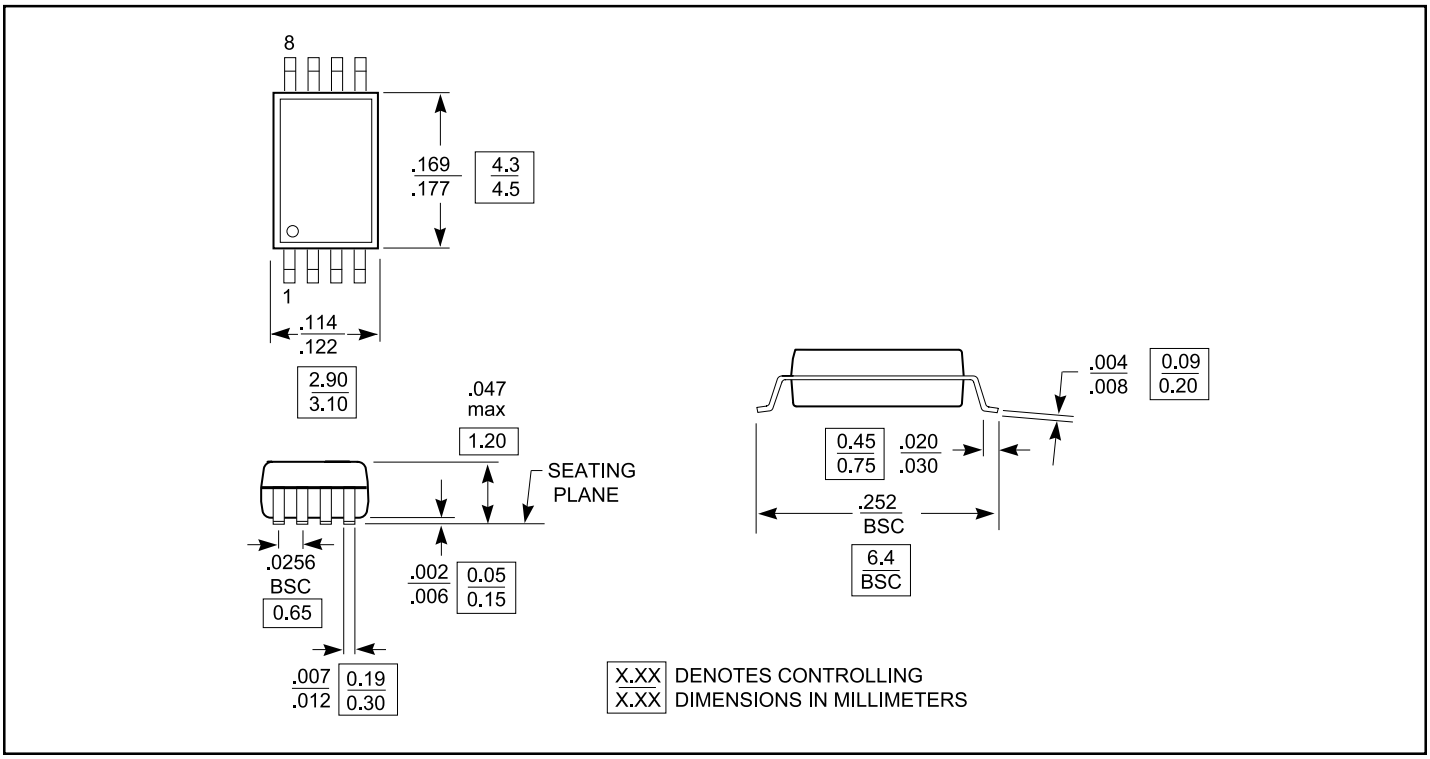


Test Circuit for t_{SLEW} ,Output slew rate on –1H device

Packaging Mechanical: 8-Pin SOIC (W)



Packaging Mechanical: 8-Pin TSSOP (L)



Ordering Information PI6C2405

Ordering Code	Packageing Code	Package Type	Operating Range
PI6C2405A-1W	W	8-pin 150-mil SOIC	Commercial
PI6C2405A-1HW	W	8-pin 150-mil SOIC	
PI6C2405A-1L	L	8-pin 173-mil TSSOP	
PI6C2405A-1HL	L	8-pin 173-mil TTSSOP	
PI6C2405A-1WE	W	Pb-free and Green, 8-pin 150-mil SOIC	
PI6C2405A-1HWE	W	Pb-free and Green, 8-pin 150-mil SOIC	
PI6C2405A-1LE	L	Pb-free and Green, 8-pin 173-mil TSSOP	
PI6C2405A-1HLE	L	Pb-free and Green, 8-pin 173-mil TSSOP	
PI6C2405A-1WI	W	8-pin 150-mil SOIC	Industrial
PI6C2405A-1HWI	W	8-pin 150-mil SOIC	
PI6C2405A-1LI	L	8-pin 173-mil TTSSOP	
PI6C2405A-1HLI	L	8-pin 173-mil TTSSOP	
PI6C2405A-1WIE	W	Pb-free and Green, 8-pin 150-mil SOIC	
PI6C2405A-1HWIE	W	Pb-free and Green, 8-pin 150-mil SOIC	
PI6C2405A-1LIE	L	Pb-free and Green, 8-pin 173-mil TTSSOP	
PI6C2405A-1HLIE	L	Pb-free and Green, 8-pin 173-mil TTSSOP	

Notes:
1. Thermal characteristics can be found on the company web site at http://www.pericom.com/packaging/
2. X = Tape/Reel